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DATE MAILED: 06/07/2006

APPLICATION NO.	FILING	DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.	
10/767,764	01/29	0/2004	Max F. Hineman	2269-5925US (03-0290.00/U	5543	
24247	7590	06/07/2006		EXAMINER		
TRASK BRITT				QUINTO, KEVIN V		
P.O. BOX 25	50					
SALT LAKE		84110		ART UNIT	PAPER NUMBER	
	•		·	2826	···	

Please find below and/or attached an Office communication concerning this application or proceeding.

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		Application No.	Applicant(s)	7		
		10/767,764	HINEMAN ET AL.			
	Office Action Summary	Examiner	Art Unit			
		Kevin Quinto	2826			
Period fo	The MAILING DATE of this communication app or Reply	ears on the cover sheet with the c	orrespondence address			
WHIC - Exter after - If NO - Failu Any r	ORTENED STATUTORY PERIOD FOR REPLY CHEVER IS LONGER, FROM THE MAILING DATE is is insolved in the may be available under the provisions of 37 CFR 1.13 SIX (6) MONTHS from the mailing date of this communication. Period for reply is specified above, the maximum statutory period were to reply within the set or extended period for reply will, by statute, eply received by the Office later than three months after the mailing and patent term adjustment. See 37 CFR 1.704(b).	ATE OF THIS COMMUNICATION 36(a). In no event, however, may a reply be tin vill apply and will expire SIX (6) MONTHS from 1, cause the application to become ABANDONE	N. nely filed the mailing date of this communicat D (35 U.S.C. § 133).			
Status						
2a)□ 3)□	Since this application is in condition for allowar	action is non-final. nce except for formal matters, pro		is		
	closed in accordance with the practice under E	х рапе Quayle, 1935 С.D. 11, 4:	53 O.G. 213.			
Dispositi	on of Claims					
5)⊠ 6)⊠ 7)□ 8)□ Application 9)□ -	Claim(s) 1-33 is/are pending in the application. 4a) Of the above claim(s) is/are withdraw Claim(s) 1-25 is/are allowed. Claim(s) 26-33 is/are rejected. Claim(s) is/are objected to. Claim(s) are subject to restriction and/or on Papers The specification is objected to by the Examiner The drawing(s) filed on is/are: a) access	vn from consideration. • election requirement. • epted or b)□ objected to by the E				
	Applicant may not request that any objection to the on Replacement drawing sheet(s) including the correction		` '	(4)		
	The oath or declaration is objected to by the Exa					
	nder 35 U.S.C. § 119					
 12) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f). a) All b) Some * c) None of: 1. Certified copies of the priority documents have been received. 2. Certified copies of the priority documents have been received in Application No. 3. Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)). * See the attached detailed Office action for a list of the certified copies not received. 						
2)	of References Cited (PTO-892) of Draftsperson's Patent Drawing Review (PTO-948) ation Disclosure Statement(s) (PTO-1449 or PTO/SB/08) No(s)/Mail Date	4) Interview Summary Paper No(s)/Mail Da 5) Notice of Informal Pa 6) Other:	(PTO-413) te atent Application (PTO-152)			

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DETAILED ACTION

Response to Arguments

1. Applicant's arguments with respect to claims 26-33 have been considered but are most in view of the new ground(s) of rejection.

Claim Rejections - 35 USC § 102

2. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

- (b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.
- 3. Claim 26, 27, 31, and 32 are rejected under 35 U.S.C. 102(b) as being anticipated by Taguchi et al. (USPN 6,645,852 B1).
- In reference to claims 26 and 31, Taguchi et al. (USPN 6,645,852 B1, hereinafter referred to as the "Taguchi" reference) discloses a structure which meets these claims. Figure 1B of Taguchi illustrates a metallic damascene structure which meets claims 26 and 31. Figure 1B of Taguchi illustrates a metallic damascene structure with a substrate (11) and a metallic layer (15) extending over at least a portion of a surface of the substrate (11). The metallic layer (15) includes an at least partially reversed oxidation injury (column 5, lines 15-67 and column 6, lines 1-36). An insulating layer (17) extends over at least a portion of the metallic layer (15). A damascene opening extends through at least a portion of the insulating layer (17) and exposes at least a

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portion of the metallic layer (15). The at least a portion of the metallic layer (15) exposed through the damascene opening comprises the at least partially reversed oxidation injury (column 5, lines 15-67 and column 6, lines 1-36) of the metallic layer (15). There is a metallic plug (26) in the damascene opening and it is in electrical connection with the metallic layer (15).

5. With regard to claims 27 and 32, Taguchi discloses that the metallic damascene structure of figure 1B is to be used in an electronic device (abstract).

Claim Rejections - 35 USC § 103

- 6. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
 - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 7. Claim 28 is rejected under 35 U.S.C. 103(a) as being unpatentable over of Taguchi et al. (USPN 6,645,852 B1) in view of Kitani (USPN 6,424,042 B1) and further in view of Oashi et al. (United States Patent Application Publication No. US 2002/0030215 A1).
- 8. With regard to claim 28, Taguchi does not disclose the use of the damascene structure in a memory device. However the use of damascene structures in memory devices is well known in the art. Kitani (USPN 6,424,042 B1) discloses that using damascene structures in memory devices has the benefit of providing an increased operation speed (column 1, lines 14-19). Oashi et al. (United States Patent Application

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Publication No. US 2002/0030215 A1, hereinafter referred to as the "Oashi" reference) discloses that a faster operation speed is a known goal in the art (p.1, paragraph 5). In view of Kitani and Oashi, it would therefore be obvious to implement the damascene structure of Taguchi in a memory device.

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- 9. Claims 29, 30, and 33 are rejected under 35 U.S.C. 103(a) as being unpatentable over Chen et al. (USPN 6,885,080 B2) in view of Oashi et al. (United States Patent Application Publication No. US 2002/0030215 A1) and further in view of Taguchi et al. (USPN 6,645,852 B1).
- 10. In reference to claims 29, 30, and 33, Chen et al. (USPN 6,885,080 B2, hereinafter referred to as the "Chen" reference) discloses an electronic device with a microprocessor and an embedded dynamic random access memory (DRAM) or integrated circuit coupled to it on the same substrate (column 1, lines 12-16). Chen does not disclose the use of damascene structures for DRAM. However the use of damascene structures in a DRAM is well known in the art. Oashi (United States Patent Application Publication No. US 2002/0030215 A1, hereinafter referred to as the "Oashi" reference) discloses a DRAM with damascene structures in figure 22. Oashi discloses that such a DRAM has a small size (p.1, paragraph 22) which is desirable in the art (p.2, paragraph 7). In view of Oashi, it would therefore be obvious to implement a DRAM with damascene structures in the electronic device of Chen. Neither Oashi nor Chen discloses the use of a metallic damascene structure with a partially reversed oxidation injury in a metallic layer. However the use of such a structure is known in the art. Taguchi et al. (USPN 6,645,852 B1) discloses a metallic damascene structure. Figure

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1B of Taguchi illustrates a metallic damascene structure with a substrate (11) and a metallic layer (15) extending over at least a portion of a surface of the substrate (11). The metallic layer (15) includes an at least partially reversed oxidation injury (column 5. lines 15-67 and column 6, lines 1-36). An insulating layer (17) extends over at least a portion of the metallic layer (15). A damascene opening extends through at least a portion of the insulating layer (17) and exposes at least a portion of the metallic layer (15). The at least a portion of the metallic layer (15) exposed through the damascene opening comprises the at least partially reversed oxidation injury (column 5, lines 15-67 and column 6, lines 1-36) of the metallic layer (15). There is a metallic plug (26) in the damascene opening and it is in electrical connection with the metallic layer (15). Taguchi discloses that this damascene structure has the advantage of providing a contact structure with low resistance and high reliability (column 7, lines 6-16). The removal of copper oxide in a contact structure in order to attain low resistance and high reliability are known goals in the art (column 1, lines 42-48, column 7, lines 6-16). In view of Taguchi, it would therefore be obvious to implement such a damascene structure in the electronic device of Chen constructed in view of Oashi in order to attain the benefit of a low resistance damascene structure.

Allowable Subject Matter

11. Claims 1-25 were allowed in a previous Office action.

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Conclusion

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Any inquiry concerning this communication or earlier communications from the examiner should be directed to Kevin Quinto whose telephone number is (571) 272-1920. The examiner can normally be reached on M-F 8AM-5PM.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Nathan Flynn can be reached on (571) 272-1915. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

KVQ